

Bipolar Transistors Silicon NPN Epitaxial Type

TTC501

1. Applications

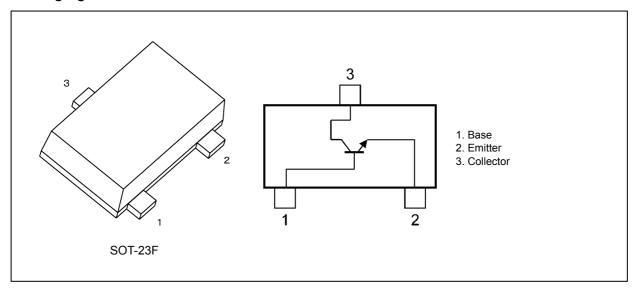
- · High-Speed Switching
- · DC-DC Converters

2. Features

- (1) AEC-Q101 qualified (Note 1)
- (2) High DC current gain: $h_{\rm FE}$ = 400 to 1000 ($I_{\rm C}$ = 0.3 A)
- (3) Low collector-emitter saturation voltage: $V_{CE(sat)} = 0.14 \text{ V (max)}$
- (4) High-speed switching: $t_f = 120 \text{ ns (typ.)}$

Note 1: For detail information, please contact our sales.

3. Packaging and Internal Circuit



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4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics			Symbol	Rating	Unit
Collector-base voltage			V_{CBO}	100	V
Collector-emitter voltage			V_{CEX}	80	V
Collector-emitter voltage			V_{CEO}	50	V
Emitter-base voltage			V_{EBO}	7	V
Collector current (DC)		(Note 1)	Ic	2.5	Α
Collector current (pulsed)		(Note 1)	I _{CP}	4.0	Α
Base current			I _B	250	mA
Collector power dissipation	DC	(Note 2)	P _C	1	W
Collector power dissipation	(t = 1 s)	(Note 2)	P _C	1.7	W
Junction temperature			Tj	150	°C
Storage temperature			T _{stg}	- 55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Device mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm ,Cu pad: 645 mm²)

5. Electrical Characteristics

5.1. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	V _{CB} = 100 V , I _E = 0 mA	_	_	100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 7 V, I _C = 0 mA	_		100	nA
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C = 10 mA, I _B = 0 mA	50	١		V
DC current gain	h _{FE} (1)	$V_{CE} = 2 \text{ V}, I_{C} = 0.3 \text{ A}$	400	-	1000	_
	h _{FE} (2)	V _{CE} = 2 V, I _C = 1 A	200			_
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 1 A, I _B = 20 mA	_	١	0.14	V
Base-emitter saturation voltage	$V_{BE(sat)}$	I _C = 1 A, I _B = 20 mA	_		1.10	V

5.2. Dynamic Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector output capacitance	C _{ob}	V_{CB} = 10 V, I_{E} = 0 mA, f = 1 MHz	1	13	1	pF
Switching time (rise time)	t _r	See Figure 5.2.1 $V_{cc} \approx 30 \text{ V}, R_L = 30 \Omega,$ $I_{B1} = 33.3 \text{ mA}, I_{B2} = 33.3 \text{ mA}$		40		ns
Switching time (storage time)	t _{stg}			500		ns
Switching time (fall time)	t _f	11B1 - 33.3 MA, 1B2 - 33.3 MA	_	120	_	ns



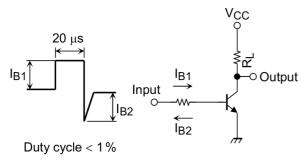


Fig. 5.2.1 Switching Time Test Circuit

6. Marking

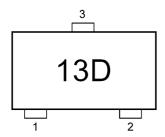
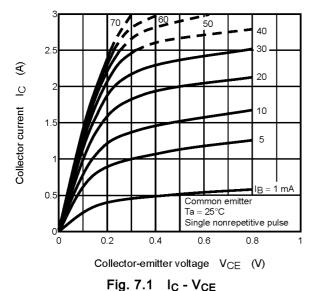


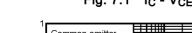
Fig. 6.1 Marking

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7. Characteristics Curves (Note)





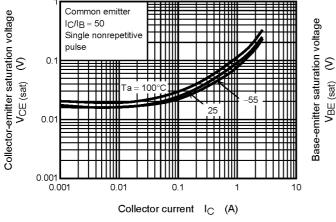


Fig. 7.3 V_{CE(sat)} - I_C

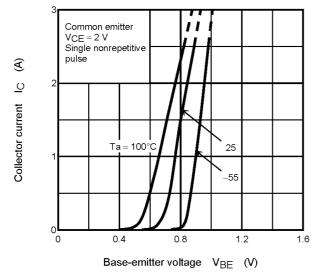


Fig. 7.5 I_C - V_{BE}

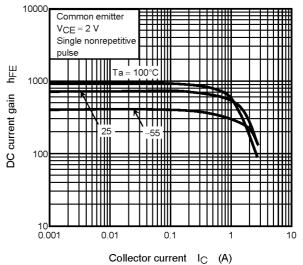


Fig. 7.2 hFE - IC

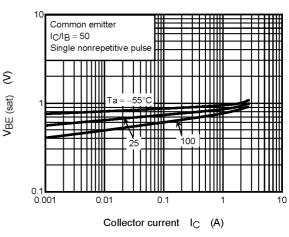


Fig. 7.4 V_{BE(sat)} - I_C



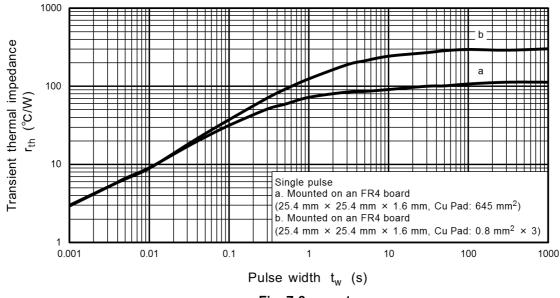


Fig. 7.6 rth - tw

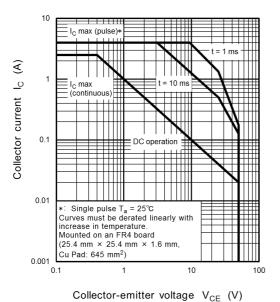


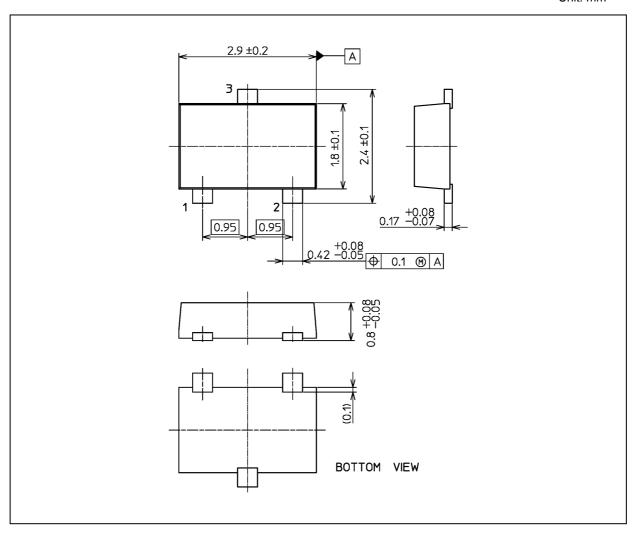
Fig. 7.7 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.011 g (typ.)

	Package Name(s)
Nickname: SOT-23F	

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